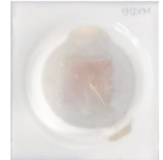


L-Spice

L-Spice packs a powerful performance with its directional light output and efficient distribution. This specialized lens optimizes brightness and minimizes glare, enhancing both visual comfort and energy efficiency. It empowers designers with newfound flexibility, enabling the creation of sleek and visually appealing lighting solutions. Whether spotlighting, accentuating specific areas, or delivering precise illumination, L-Spice illuminates the way to a brighter and more focused future.



Features:

- > Super high brightness surface mount LED automotive exterior applications.
- > 60° viewing angle.
- > Compact package outline (LxW) of 2.8 x 3.0mm.
- > Low height profile - 1.96mm max.
- > Low thermal resistance.
- > Superior corrosion robustness.
- > Compatible to IR reflow soldering.
- > Compliance to automotive standard; AEC-Q102.
- > Environmental friendly; RoHS compliance.
- > The matt surface of the lens diffuses light and improve homogeneity.



Applications:

- > Automotive: Exterior application: eg: Turn Signal

Optical Characteristics at Tj=25°C

Part Number	Color	Viewing Angle°	Luminous Flux Appx. 1.2 60mA (lm)			Luminous Intensity Appx. 1.1 60mA (mcd) Typ.
			Min.	Typ.	Max.	
C6Y-MHG-LM3-4	Yellow, 592 nm	60	10.70	14.00	18.10	10000
C6Y-MHG-K3M2-3	Yellow, 589 nm	60	9.35	12.50	15.80	8900
C6Y-MHG-KL3-2	Yellow, 586 nm	60	8.20	11.00	13.90	7800

Electrical Characteristics at Tj=25°C

Part Number	Vf @ If = 60mA Appx. 3.1			Vr @ Ir = 10uA Appx. 6.1
	Min. (V)	Typ. (V)	Max. (V)	Min. (V)
C6Y-MHG	2.10	2.40	2.70	12

Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	80	mA
Peak pulse current; (Ts = 55°C, tp ≤ 100µs, Duty cycle = 0.03)	300	mA
Reverse voltage Appx. 6.1	12	V
ESD threshold (HBM)	2	KV
LED junction temperature	125	°C
Operating temperature	-40 ... +115	°C
Storage temperature	-40 ... +125	°C
Thermal resistance (Rated current = 60mA, Ts = 25 °C)		
- Real Thermal Resistance Junction / solder point, Rth JS real Yellow (typ = 35)	46	K/W
- Electrical Thermal Resistance Junction / solder point, Rth JS el Yellow (typ = 30)	39	K/W

Wavelength Grouping at Tj= 25°C

Color	Group	Wavelength distribution (nm) <i>Appx. 2.2</i>
C6x; Yellow	Full	583 - 595
	W	583 - 586
	X	586 - 589
	Y	589 - 592
	Z	592 - 595

Luminous Flux Group at Tj=25°C

Brightness Group	Luminous Flux <i>Appx. 1.2</i> (lm)
K2	8.20 ... 9.35
K3	9.35 ... 10.70
L2	10.70 ... 12.20
L3	12.20 ... 13.90
M2	13.90 ... 15.80
M3	15.80 ... 18.10

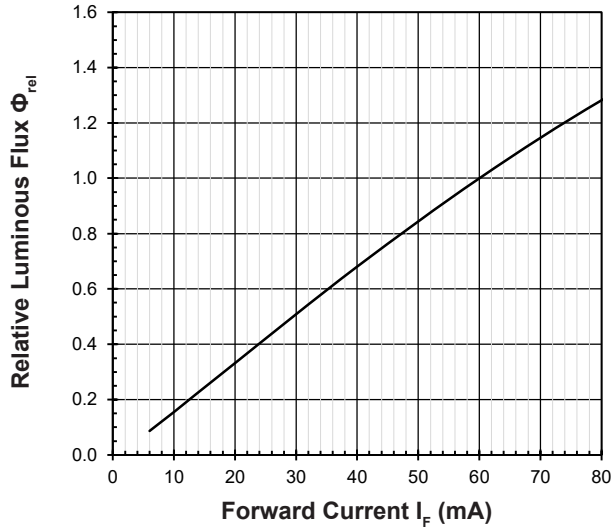
Vf Bining (Optional)

Vf Bin @ 60 mA	Forward Voltage (V) <i>Appx. 3.1</i>
V05	2.10 ... 2.25
V06	2.25 ... 2.40
V07	2.40 ... 2.55
V08	2.55 ... 2.70

Please consult sales and marketing for special part number to incorporate Vf bining.

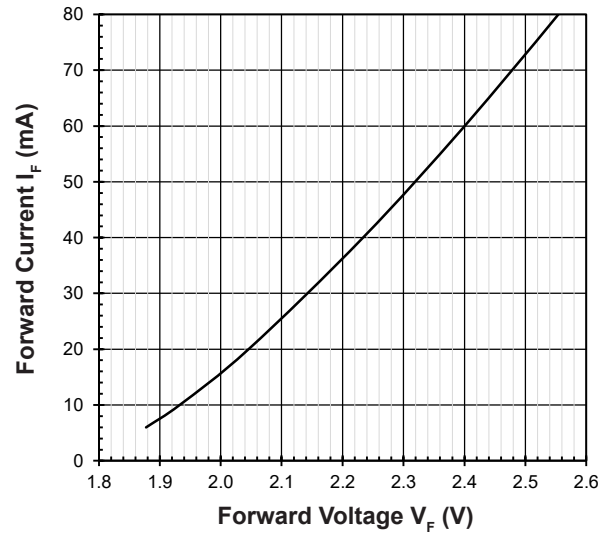
Relative Luminous Flux Vs Forward Current Appx. 4.1

$$\Phi_V/\Phi_V(60\text{mA}) = f(I_F); T_j = 25^\circ\text{C}$$



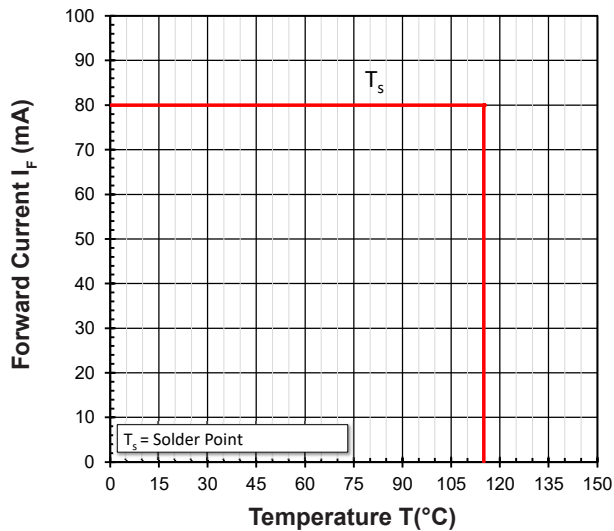
Forward Current Vs Forward Voltage Appx. 4.1

$$I_F = f(V_F); T_j = 25^\circ\text{C}$$



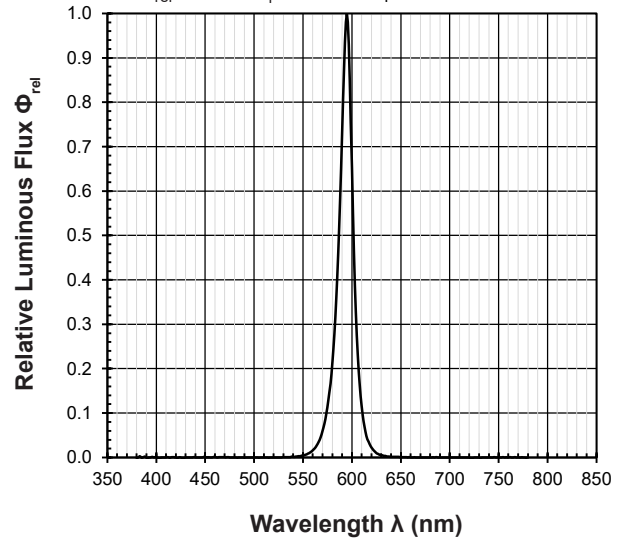
Maximum Current Vs Temperature

$$I_F = f(T)$$



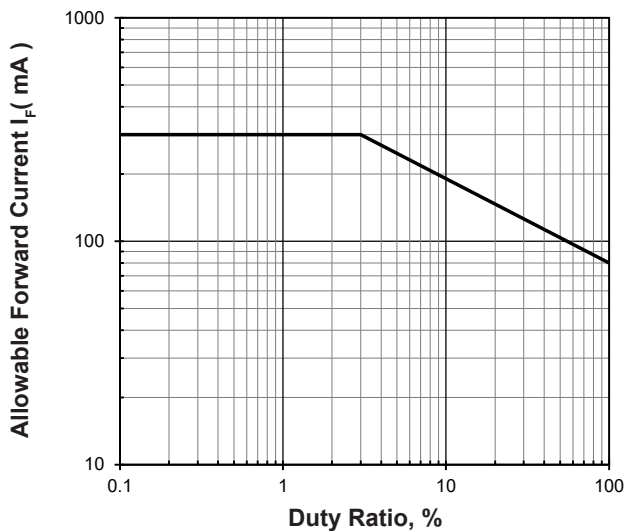
Relative Spectral Emission Appx. 4.1

$$\Phi_{\text{rel}} = f(\lambda); T_j = 25^\circ\text{C}; I_F = 60\text{mA}$$

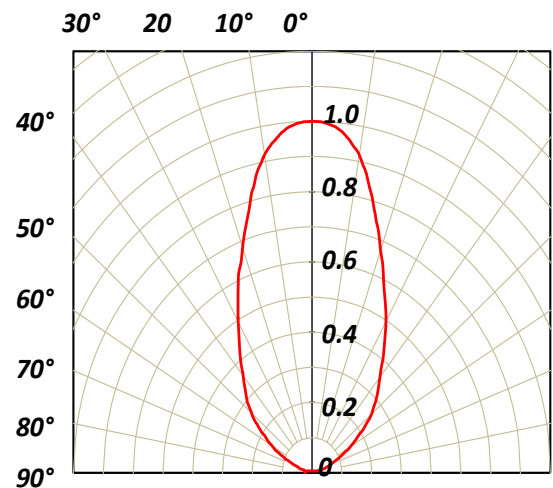


Allowable Forward Current Vs Duty Ratio

$$(T_s = 55^\circ\text{C}; t_p \leq 100\mu\text{s})$$

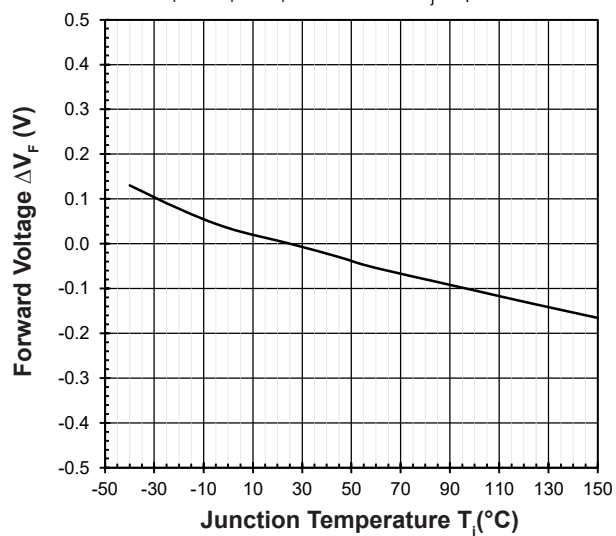


Radiation Pattern Appx. 4.1



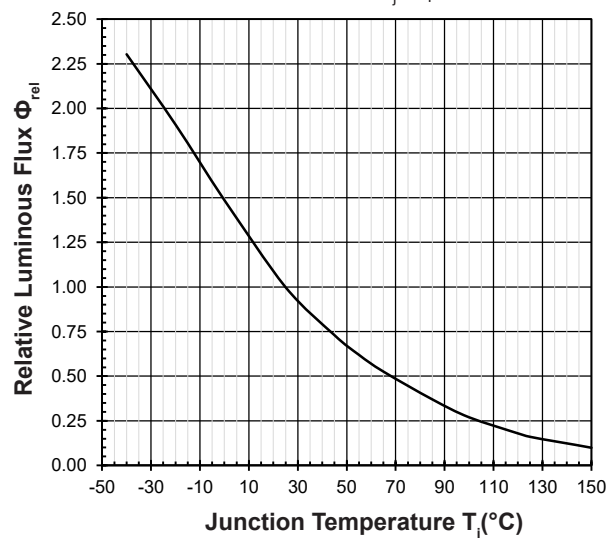
Forward Voltage Vs Junction Temperature Appx. 4.1

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 60\text{mA}$$



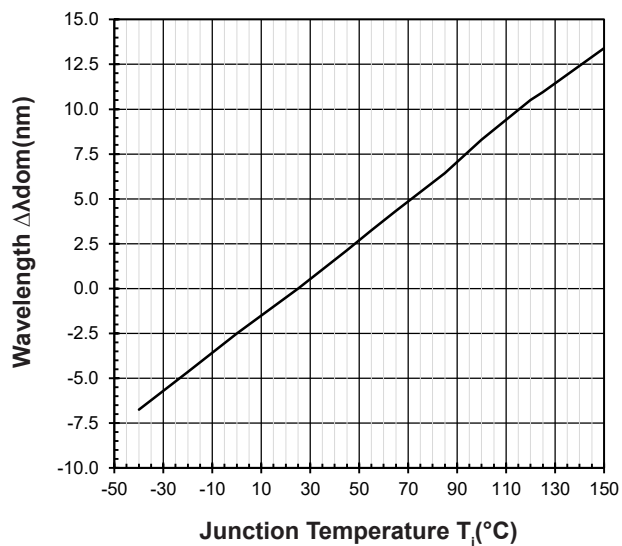
Relative Luminous Flux Vs Junction Temperature Appx. 4.1

$$\Phi_V/\Phi_V(25^\circ\text{C}) = f(T_j); I_F = 60\text{mA}$$

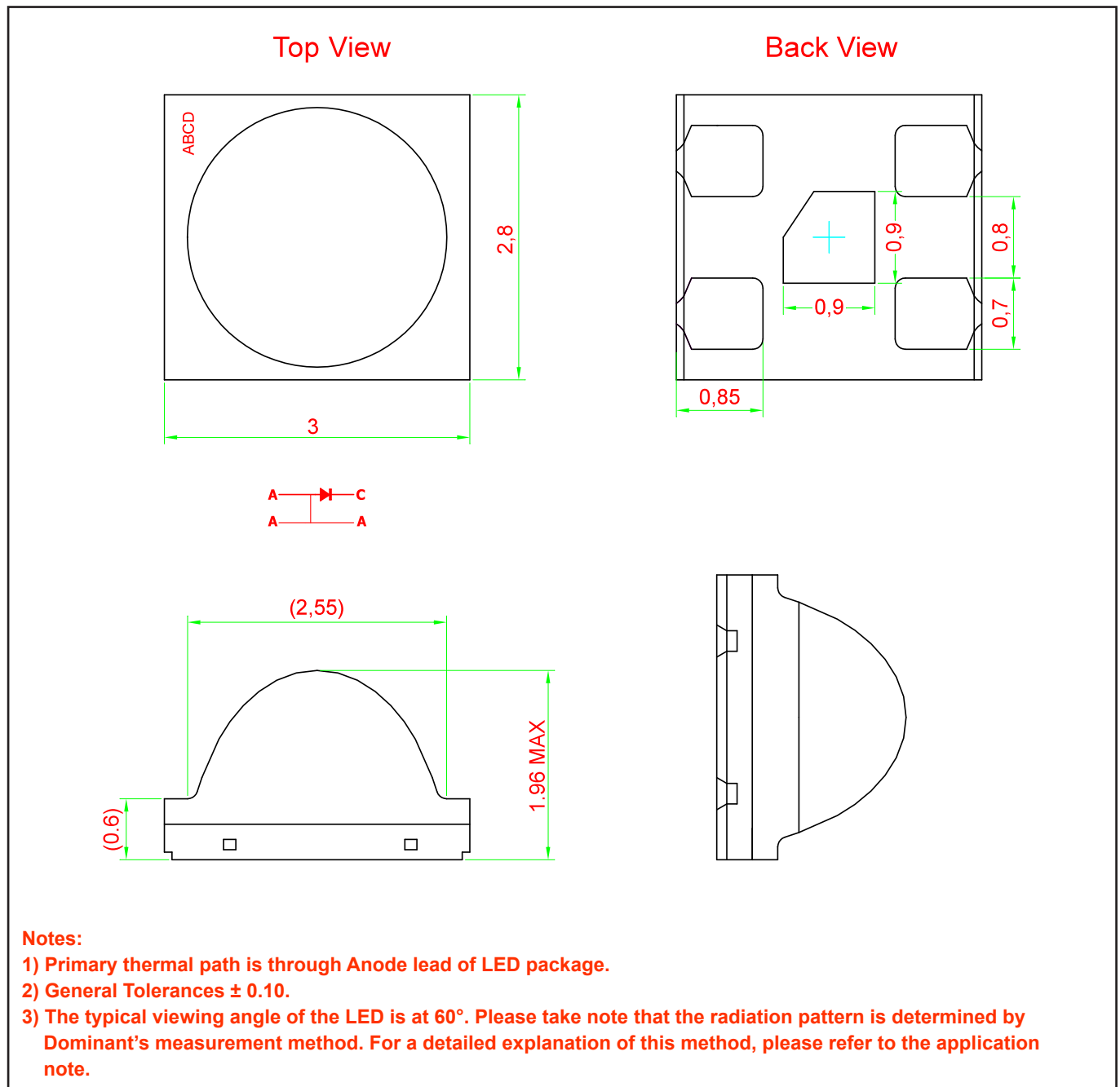


Wavelength Vs Junction Temperature Appx. 4.1

$$\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25^\circ\text{C}) = f(T_j); I_F = 60\text{mA}$$



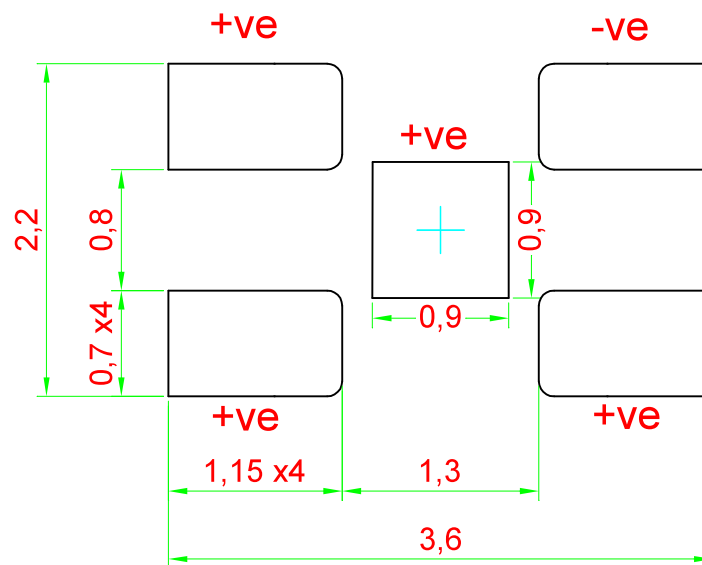
L-Spice AllnGaP: C6Y-MHG Package Outlines Appx. 5.1



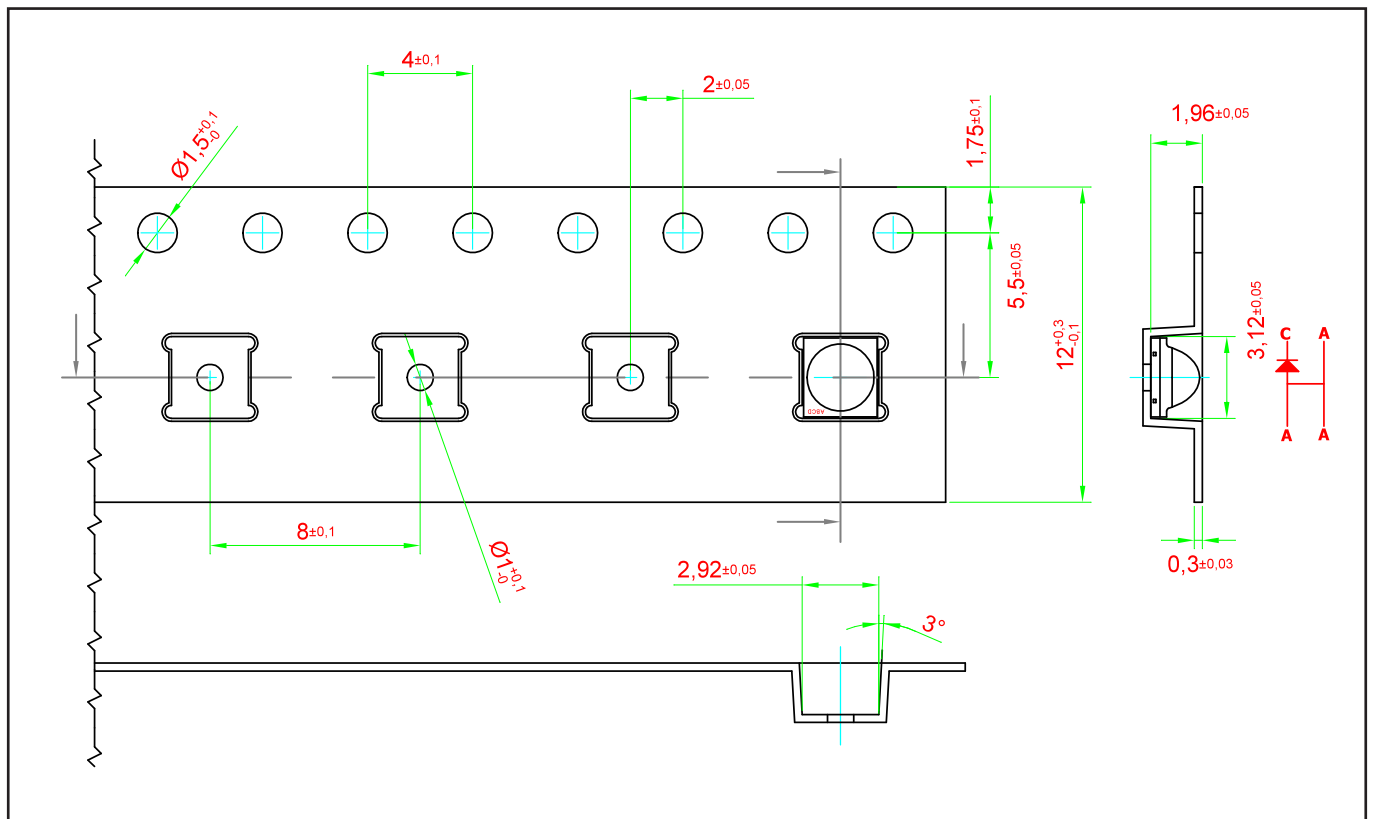
Material

Material	
Lead-frame	Cu Alloy With Au Plating
Package	Heat Resistant Polymer
Encapsulant	Silicone Resin
Soldering Leads	Sn Plating

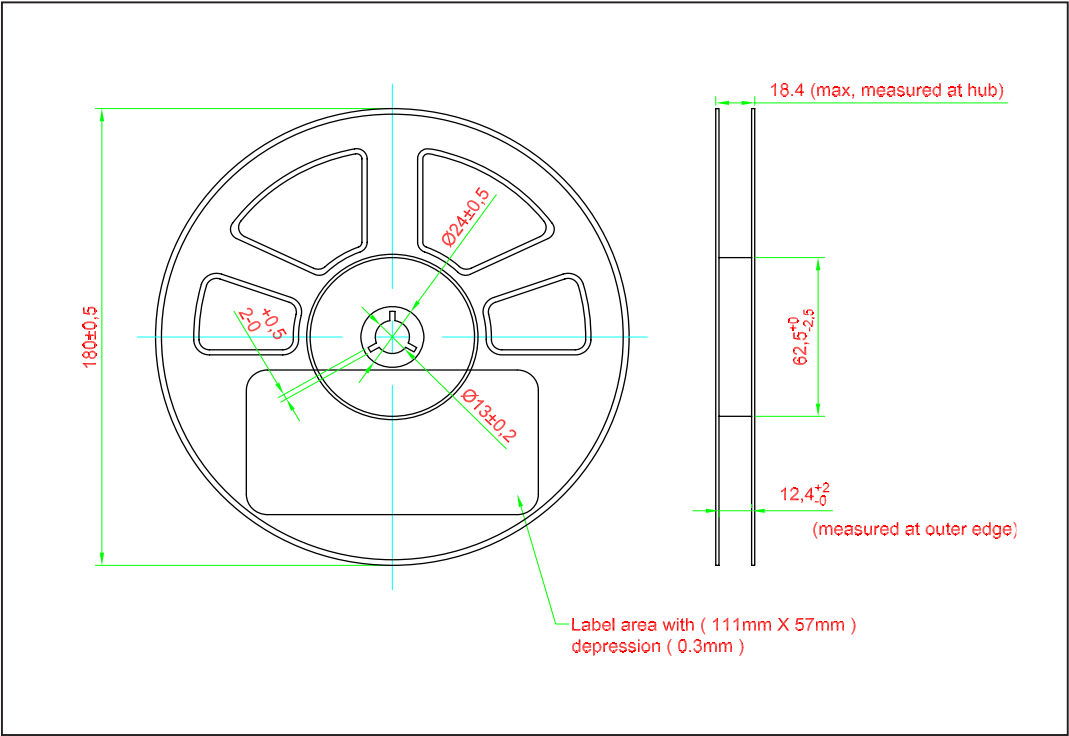
Recommended Solder Pad *Appx. 5.1*



Taping and orientation Appx. 5.1



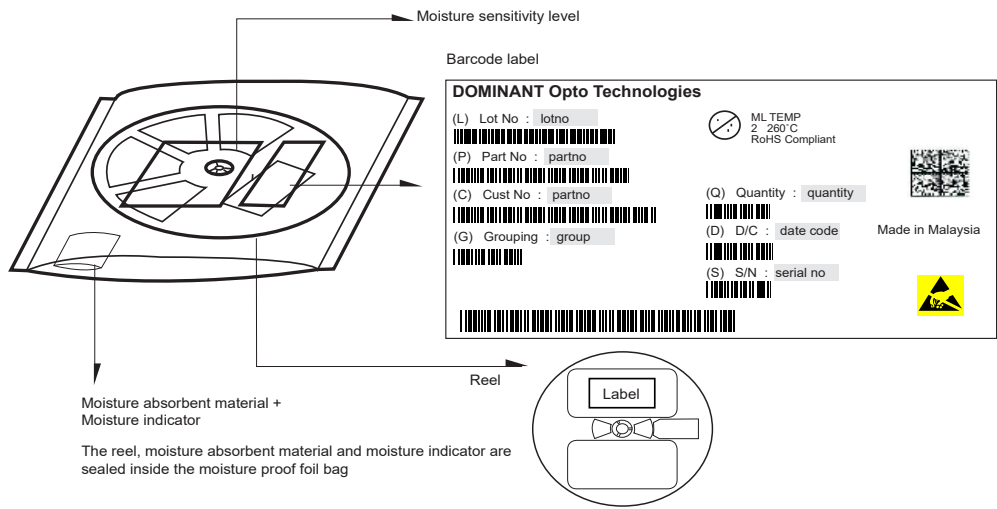
Packaging Specification



	Reel Diameter (mm)	Quantity (pcs)	*Ordering Number
Standard Packing	180	1000	C6Y-MHG-xxx-1

Notes:
* For ordering purpose only. Please consult sales and marketing for details.

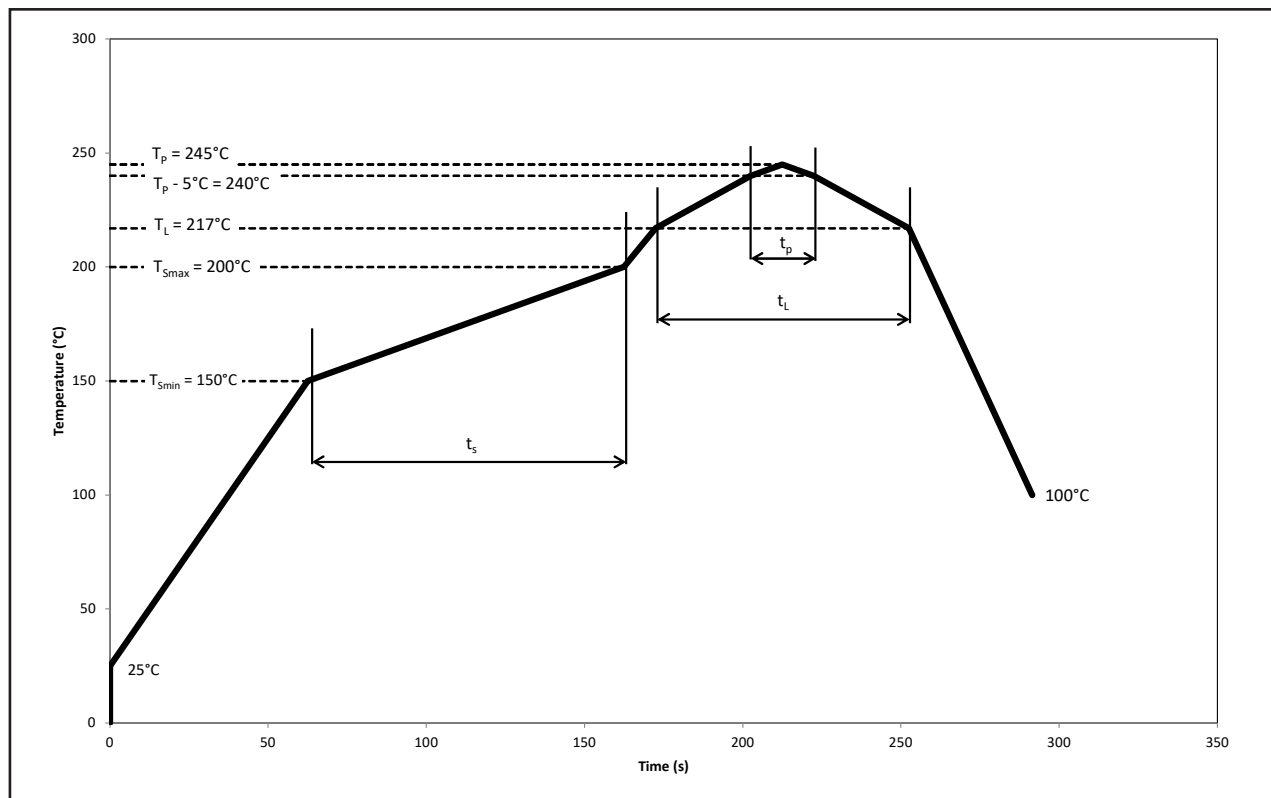
Packaging Specification



Quantity per bag (pcs)	Average 1pc L-Spice (g)	1 completed bag (g)
1000	0.0170	80 ± 10

Recommended Pb-free Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Min.	Pb-Free Assembly		Unit
			Recommended	Max.	
Ramp-up rate to preheat 25°C to T _{smin}	-	-	2	3	°C/s
Time t _s T _{smin} to T _{smax}	t _s	60	100	120	s
Ramp-up rate to peak T _L to T _p	-	-	2	3	°C/s
Liquidous temperature	T _L	-	217	-	°C
Time above liquidous temperature	t _L	60	80	150	s
Peak temperature	T _p	-	245	260	°C
Time within 5°C of the specified peak temperature T _p - 5°C	t _p	10	20	30	s
Ramp-down rate T _p to 100°C	-	-	3	6	°C/s
Time 25°C to T _p	-	-	-	480	s

Appendix

1) **Brightness:**

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).

2) **Color:**

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (accordingly to GUM with a coverage factor of $k=3$).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 0.5\text{nm}$ and an expanded uncertainty of $\pm 1\text{nm}$ (accordingly to GUM with a coverage factor of $k=3$).

3) **Voltage:**

- 3.1 Forward Voltage, V_f is measured when a current pulse of 8 ms(typ) with an internal reproducibility of $\pm 0.05\text{V}$ and an expanded uncertainty of $\pm 0.1\text{V}$ (accordingly to GUM with a coverage factor of $k=3$).

4) **Typical Values:**

- 4.1 Due to the specific conditions of semiconductor devices' manufacturing processes, the provided typical data and calculated correlations of technical parameters should only be considered as statistical values. It is important to note that the actual parameters of individual devices may deviate from these typical data, calculated correlations or the typical characteristic line. Dominant reserves the right to update this typical data without prior notice, particularly in response to technical enhancements.

5) **Tolerance of Measure**

- 5.1 Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimension are specific in mm.

6) **Reverse Voltage:**

- 6.1 Not designed for reverse operation. Continuous reverse voltage can cause migration and LED damage.

7) **Corrosion Robustness:**

- 7.1 Test conditions: $40\text{ }^{\circ}\text{C}$ / $90\text{ \% rh}$ / $15\text{ ppm H}_2\text{S}$ / 336 h .
= Stricter than IEC 60068-2-43 (H_2S) [$25\text{ }^{\circ}\text{C}$ / $75\text{ \% rh}$ / $10\text{ ppm H}_2\text{S}$ / 21 days].

Revision History

Page	Subjects	Date of Modification
-	Initial Release	06 Jun 2023
1	Update Features	11 Sep 2023
6	Update Package Outline	24 May 2024

NOTE

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Dispose of product is in accordance with local, regional, national and international regulations.

About Us

DOMINANT Opto Technologies is a dynamic company that is amongst the world's leading automotive LED manufacturers. With an extensive industry experience and relentless pursuit of innovation, DOMINANT's state-of-art manufacturing and development capabilities have become a trusted and reliable brand across the globe. More information about DOMINANT Opto Technologies, an IATF 16949 and ISO 14001 certified company, can be found under <http://www.dominant-semi.com>.

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